## WHAT IS CLAIMED IS:

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1. An electroluminescent phosphor, comprising phosphor particles and electron-emitting material particles,

wherein the electron-emitting material particles are not originating from atoms constituting the host material of the phosphor and an activator, and the electron-emitting material particles are contained inside the phosphor particles or included between the phosphor particles in close contact with them.

- 2. The electroluminescent phosphor according to claim 1, wherein the electron-emitting material has an electric resistivity of  $10^7~\Omega^{\circ}\text{cm}$  or less.
  - 3. The electroluminescent phosphor according to claim 1 or 2, wherein the electron-emitting material particles have an aspect ratio (L/D) of 1.5 or more, the aspect ratio (L/D) being a ratio of a major axis (L) and a minor axis (D).
  - 4. The electroluminescent phosphor according to any one of claims 1 to 3, wherein the electron-emitting material particles have a particle diameter which does not exceed the particle diameter of the phosphor particles.
  - 5. The electroluminescent phosphor according to any one of claims 1 to 4, wherein a content ratio of the electron-emitting material particles to the phosphor particles is 0.00001 to 50 weight%.
- 6. A method for manufacturing an electroluminescent phosphor, comprising:

mixing a phosphor material including elements constituting the host material of a phosphor and an activator or a compound

containing the elements and electron-emitting material particles; and

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baking the prepared mixture by heating to yield an electroluminescent phosphor comprising phosphor particles and the electron-emitting material particles contained in the phosphor particles.

7. A method for manufacturing an electroluminescent phosphor, comprising:

mixing a phosphor material including elements constituting the host material of a phosphor and an activator or a compound containing the elements, and heating for baking the mixture to prepare phosphor particles;

mixing the phosphor particles prepared in the previous step with electron-emitting material particles; and

baking the mixture prepared in the previous mixing step by heating to produce an electroluminescent phosphor comprising the phosphor particles and the electron-emitting material particles contained in the phosphor particles.

- 8. The method for manufacturing an electroluminescent phosphor according to claim 6 or 7, further comprising mixing and heating the electroluminescent phosphor produced in the baking step and the phosphor material to bake the mixture.
- 9. A method for manufacturing an electroluminescent phosphor, comprising:

mixing a phosphor material including elements constituting a host material of a phosphor and an activator or a compound containing the elements, and heating for baking the mixture to prepare phosphor particles;

mixing the phosphor particles prepared in the previous step and electron-emitting material particles; and

pressing the mixture prepared in the mixing step at normal temperature or while heating to closely contact the phosphor particles with the electron-emitting material particles included between phosphor particles.

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- 10. An electroluminescent element, comprising a light emitting layer containing the electroluminescent phosphor according to any one of claims 1 to 5.
- 11. The electroluminescent element according to claim 10, comprising a light emitting layer having the electroluminescent phosphor dispersed into a dielectric matrix, a transparent electrode layer which is disposed on one main surface of the light emitting layer, and a backplate electrode layer which is disposed on the other main surface of the light emitting layer with a dielectric layer therebetween.
  - 12. An electroluminescent element, comprising:

a light emitting layer including phosphor particles and electron-emitting material particles not originating from atoms constituting the host material of the phosphor and an activator,

wherein the electron-emitting material comprises a conductive compound, and a content ratio of the electron-emitting material in the light emitting layer is 1 to 75 weight%.

13. The electroluminescent element according to claim 12, comprising a transparent electrode layer which is disposed on one main surface of the light emitting layer and a backplate electrode layer which is disposed on the other main surface of the light emitting layer with a dielectric layer therebetween.

- 14. The electroluminescent element according to claim 12 or 13, wherein the electron-emitting material has an electric resistivity of  $10^7~\Omega$  cm or less.
- of claims 12 to 14, wherein the electron-emitting material particles are fine particles including ITO (Indium Tin Oxide) as a main component.
  - of claims 12 to 14, wherein the electron-emitting material particles are fine particles including ATO (Antimony Tin Oxide) as a main component.

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17. An electroluminescent element, comprising:
a light emitting layer;

first and second electrode layers which are disposed on both surfaces of the light emitting layer; and

an apparatus for applying an electric field between the electrode layers,

wherein the light emitting layer is formed of lamination of a phosphor layer of at least one layer and an electron emission source layer of at least one layer including an electron-emitting material not originating from the atoms constituting the host material of the phosphor and an activator.

- 18. The electroluminescent element according to claim 17, wherein an insulating layer is disposed between at least one of the first and second electrode layers and the light emitting layer.
- 19. The electroluminescent element according to claim 17 or 18, wherein the electron-emitting material has an electric

resistivity of  $10^{-3}$  to  $10^{8}~\Omega^{\bullet}cm$ , and an electron emission source layer containing the electron-emitting material has a surface irregularity of 40  $\mu m$  or less.

- of claims 17 to 19, wherein the electron-emitting material is fine particles which have at least one type selected from ITO (Indium Tin Oxide), ATO (Antimony Tin Oxide) and conductive ZnO as a main component or such fine particles coated with an insulating material.
- of claims 17 to 19, wherein the electron emission source layer is a thin film which has at least one type selected from ITO, ATO and conductive ZnO as a main component and has a surface irregularity.